

ARF1500

40MHz



750W

RF POWER MOSFET

N-CHANNEL ENHANCEMENT MODE

The ARF1500 is an RF power transistor designed for very high power scientific, commercial, medical and industrial RF power generator and amplifier applications up to 40 MHz.

• Specified 125 Volt, 27.12 MHz Characteristics:

Output Power = 750 Watts.

Gain = 17dB (Class C)

Efficiency > 75%

- High Performance Power RF Package.
- Very High Breakdown for Improved Ruggedness.
- Low Thermal Resistance.
- Nitride Passivated Die for Improved Reliability.

MAXIMUM RATINGS All Ratings: $T_C = 25$ °C unless otherwise specified.

| Symbol | Parameter | ARF 1500 | UNIT |
|-------------------|--|------------|-------|
| V _{DSS} | Drain-Source Voltage | 500 | Volts |
| I _D | Continuous Drain Current @ T _C = 25°C | 60 | Amps |
| V_{GS} | Gate-Source Voltage | ±30 | Volts |
| P _D | Total Device Dissipation @ T _C = 25°C | 1500 | Watts |
| T_J , T_{STG} | Operating and Storage Junction Temperature Range | -55 to 200 | 00 |
| T _L | Lead Temperature: 0.063" from Case for 10 Sec. | 300 | °C |

STATIC ELECTRICAL CHARACTERISTICS

| Symbol | Characteristic / Test Conditions | | TYP | MAX | UNIT | |
|------------------------|--|------|------|------|---------|--|
| BV _{DSS} | Drain-Source Breakdown Voltage (V _{GS} = 0V, I _D = 250μA) | 500 | | | Volto | |
| V _{DS(ON)} | On State Drain Voltage (1) (I _{D(ON)} = 30A, V _{GS} = 10V) | | 5.6 | 8 | 8 Volts | |
| | Zero Gate Voltage Drain Current (V _{DS} = 500V, V _{GS} = 0V) | | | 100 | | |
| I _{DSS} | Zero Gate Voltage Drain Current (V _{DS} = 400V, V _{GS} = 0V, T _C = 125°C) | | | 1000 | μΑ | |
| I _{GSS} | Gate-Source Leakage Current (V _{GS} = ±30V, V _{DS} = 0V) | | | ±400 | nA | |
| g _{fs} | Forward Transconductance (V _{DS} = 25V, I _D = 30A) | 3 | 13.5 | | mhos | |
| V _{isolation} | RMS Voltage (60Hz Sinewave from terminals to mounting surface for 1 minute) | 2500 | | | Volts | |
| V _{GS(TH)} | Gate Threshold Voltage $(V_{DS} = V_{GS}, I_{D} = 50 \text{mA})$ | 3 | | 5 | Volts | |

THERMAL CHARACTERISTICS

| Symbol | Characteristic (per package unless otherwise noted) | | TYP | MAX | UNIT |
|-----------------|---|--|------|------|--------|
| $R_{\theta JC}$ | Junction to Case | | | 0.12 | 90/14/ |
| $R_{\theta CS}$ | Case to Sink (Use High Efficiency Thermal Joint Compound and Planar Heat Sink Surface.) | | 0.09 | | °C/W |

📆 🚓 CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

| Symbol | Characteristic | Test Conditions | MIN | TYP | MAX | UNIT |
|---------------------|------------------------------|-----------------------------|-----|------|------|------|
| C _{iss} | Input Capacitance | V _{GS} = 0V | | 3920 | 4800 | |
| C _{oss} | Output Capacitance | V _{DS} = 150V | | 350 | 480 | pF |
| C _{rss} | Reverse Transfer Capacitance | f = 1 MHz | | 100 | 120 | |
| t _{d(on)} | Turn-on Delay Time | V _{GS} = 15V | | 7.5 | | |
| t _r | Rise Time | V _{DD} = 250 | | 6.0 | | ns |
| t _{d(off)} | Turn-off Delay Time | I _D = 60A @ 25°C | | 20 | | 113 |
| t _f | Fall Time | $R_G = 1.6 \Omega$ | | 10 | | |

FUNCTIONAL CHARACTERISTICS

| Symbol | Characteristic | Test Conditions | MIN | TYP | MAX | UNIT |
|-----------------|------------------------------------|-------------------------------|--------|----------|----------|---------|
| G _{PS} | Common Source Amplifier Power Gain | f = 27.12 MHz | 17 | 19 | | dB |
| η | Drain Efficiency | $V_{GS} = 0V$ $V_{DD} = 125V$ | 70 | 75 | | % |
| Ψ | Electrical Ruggedness VSWR 10:1 | P _{out} = 750W | No Deg | radation | in Outpu | t Power |

¹ Pulse Test: Pulse width < 380 µS, Duty Cycle < 2%.

APT Reserves the right to change, without notice, the specifications and information contained herein.

Table 1 - Typical Class AB Large Signal Impedance -- ARF1500

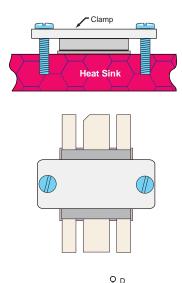
| F (MHz) | Z _{in} (Ω) | Z _{OL} (Ω) |
|---------|---------------------|---------------------|
| 2.0 | 6.7-j 12 | 7.5 -j 0.8 |
| 13.5 | 0.45 -j 2.5 | 7.1 -j 1.7 |
| 27 | 0.22 -j 0.67 | 6.1 -j 3.0 |
| 40 | 0.2 + j .19 | 5.0 -j 3.6 |

 Z_{in} - Gate shunted with 25 Ω I_{DQ} = 100mA Z_{OL} - Conjugate of optimum load for 750 Watts output at V_{dd} = 125V

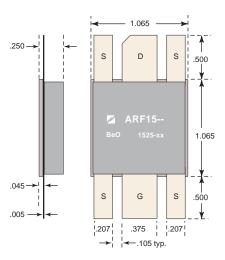
Thermal Considerations and Package Mounting:

The rated 1500W power dissipation is only available when the package mounting surface is at 25°C and the junction temperature is 200°C. The thermal resistance between junctions and case mounting surface is 0.12 °C/W. When installed, an additional thermal impedance of 0.1°C/W between the package base and the mounting surface is typical. Insure that the mounting surface is smooth and flat. Thermal joint compound must be used to reduce the effects of small surface irregularities. The heatsink should incorporate a copper heat spreader to obtain best results.

The package is designed to be clamped to a heatsink. A clamped joint maintains the required mounting pressure while allowing for thermal expansion of both the device and the heat sink. A simple clamp, and two 6-32 (M3.5) screws can provide the minimum 125 lb required mounting force. T=12 in-lb.

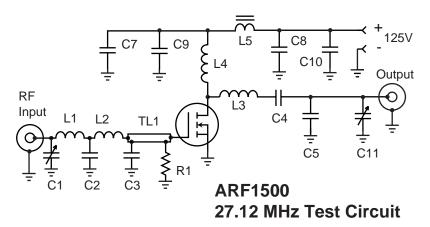






HAZARDOUS MATERIAL WARNING

The ceramic portion of the device between leads and mounting surface is beryllium oxide, BeO. Beryllium oxide dust is toxic when inhaled. Care must be taken during handling and mounting to avoid damage to this area. These devices must never be thrown away with general industrial or domestic waste.

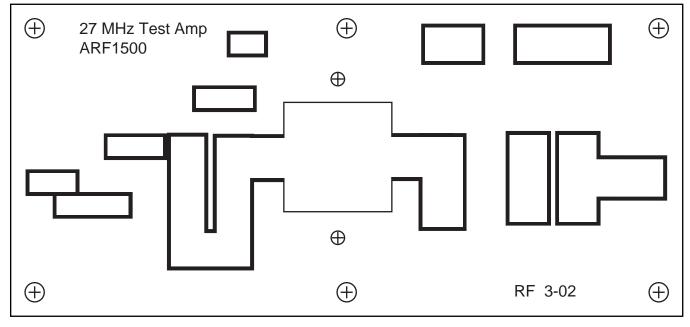


C1,C11 ARCO 465 50-450pF mica trimmer C2 1500pF ATC 700B
C3 2x 3300 pF ATC 700B
C4 8200pF 500V NPO ceramic
C5 150pF 500V NPO
C7-C8 .1uF 250V ceramic chip
C9- C10 1000pF Z5U 500V
L1 120 nH 5t #20 .25"d .3"I
L2 20 nH #20 hairpin loop .3" x .125"
L3 175 nH - 4t #10 .625" dia .875" I
L4 2uH - 22t #24 enam. .312" dia.
L5 500nH 2t on 850u .5" bead

R1 51 Ω .5W

TL1 .25" x 1.75" (30 $\Omega)$ Stripline

Parts placement



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